HR1161PDS

InAlGaAs PIN Preamp

HITACHI

ADE-208-1513A (Z)

Preliminary Rev.1 Mar. 2002

Description

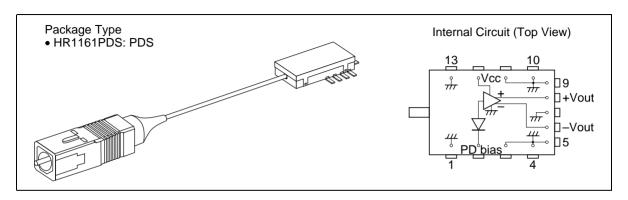
The HR1161PDS is the dual output type receiver for $10 \text{ Gb/s} \ 1.3 \ \mu\text{m}$ short and medium haul communication systems incorporated with InAlGaAs PIN photo diode and SiGe Preamp. Optical signal is launched into the small non-hermetic ceramic package through single mode fiber pigtail terminated with SC type connector.

Features

- Small non-hermetic ceramic package
- Low voltage operation ($V_{CC} = +3.3 \text{ V}$, Vpd = +5 V)
- Single mode fiber attached

Fiber Specifications

Mode field diameter: 9.5 ± 1.0 μm
 Cutoff wavelength: 1.10 to 1.27 μm
 Outer diameter: 125 μm nominal
 Jacket diameter: 900 μm nominal
 Fiber minimum bend radius: 30 mm





HR1161PDS

Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

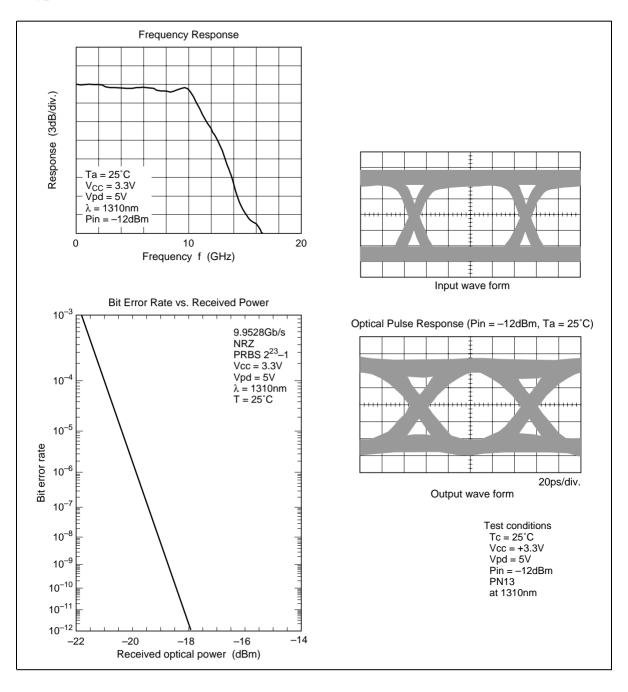
Item	Symbol	Value	Unit	Condition
Operating temperature	Topr	−0 to +85	°C	
Storage temperature	Tstg	-40 to +85	°C	
IC supply voltage	V _{cc}	-0.5 to +5	V	
PD supply voltage	Vpd	–0.5 to +15	V	
Input power	P _o max	2	dBm	

Optical and Electrical Characteristics

 $(Ta = 25^{\circ}C)$

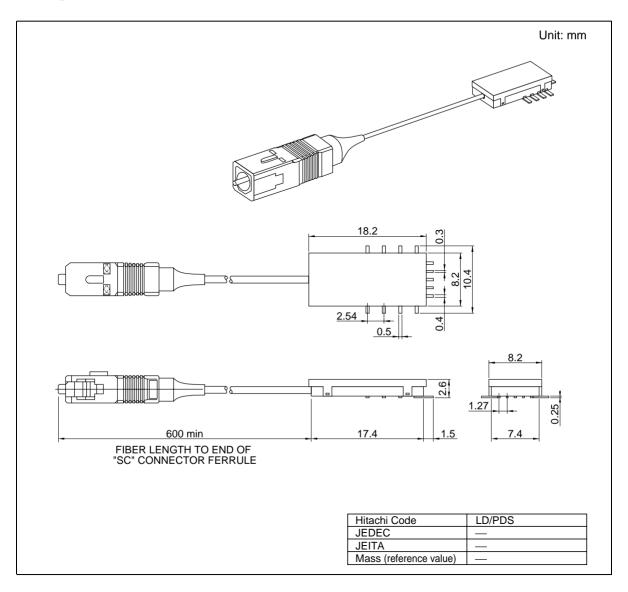
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Wavelength range	λ	1260	_	1360	nm	
Responsivity	Resp	0.7	0.8	_	A/W	V_{cc} = +3.3 V, Vpd = +5.0 V, λ = 1310 ± 5 nm, Pin = 100 μ W
Transimpedance	T _z	340	590	730	Ω	
Bandwidth	BW	7	8	_	GHz	$V_{\rm cc}$ = +3.3 V, Vpd = +5.0 V, Pin = -12 dBm, -3 dB, ZI = 50 Ω , AC coupled
Sensitivity	P _s	_	-18	–17	dBm	V_{cc} = +3.3 V, Vpd = +5.0 V, λ = 1310 \pm 5 nm, ZI = 50 Ω , AC coupled
Overload	Pmax	0.5	3	_	dBm	V_{cc} = +3.3 V, Vpd = +5.0 V, λ = 1310 \pm 5 nm, ZI = 50 Ω , AC coupled
Positive supply current	I _{cc}	10	46	62	mA	$V_{cc} = +3.3 \text{ V}, \text{ Vpd} = +5.0 \text{ V},$ Pin = 0
Positive supply voltage	V _{cc}	3.0	3.3	3.6	V	Recommended V _{cc} value
PD supply voltage	Vpd	4.7	5.0	5.3	V	Recommended Vpd value
Optical return loss	ORL	_	_	-27	dB	

Typical Characteristic Curves



HR1161PDS

Pacage Dimensions



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